

MYPro series MY300LX™

pick-and-place

Specifications April 2022 MYCRONIC 0 0 0

Specifications MYPro series **MY300LX™**

PLACEMENT SPEED AND ACCURACY		
MY300LX-11/15		
Rated speed (1)	16,000 CPH	
IPC 9850 chip net throughput (2,3)	13,800CPH	
IPC 9850 chip tact time (3)	0.250s	
IPC 9850 chip repeatability 3σ (X, Y, Theta) $^{(3,6)}$	45μm, 1.8°	
IPC 9850 chip accuracy @ Cpk = 1.33 (X, Y, Theta $^{(5,7)}$	75µm, 2.6°	
IPC 9850 fine pitch repeatability 3σ (X, Y, Theta) $^{(4)}$	21µm, 0.05°	
IPC 9850 fine pitch accuracy @ Cpk = 1.33 (X, Y, Theta) (4,5)	35μm, 0.09°	

The above specification achieved with a machine configuration including high precision mounthead (Midas), high speed mounthead (HYDRA Z8L), line scan vision system (LVS), inline conveyor T460 and 15mm component max height. The IPC 9850 net throughput and accuracy numbers are obtained simultaneously, with the same machine settings. The rated speed value is obtained under conditions optimized for speed.

- (1) Depending on component and application.
 (2) According to IPC 9850. Net throughput = (no of parts x 3,600)/(board build time + board transfer time).
 (3) According to IPC 9850 0402C verification panel.
 (4) According to IPC 9850 QFP64/QFP100 verification panel.
 (5) According to IPC 9850 Cpk 1.33 = 4σ+offset.
 (6) Chip repeatability with high precision head 35µm, 1.5°
 (7) Chip accuracy with high precision head, 63µm, 2.2°

SYSTEM FEATURES
MY300LX
On-the-fly mount order optimization
Vision autoteach with snap-to-grid
Automatic illumination settings
Intelligent feeder concept—Agilis
Automatic feeder and component recognition
On-the-fly feeder loading
Dynamic feeder positions
Automatic board stretch compensation
Automatic conveyor width adjustment
Intelligent surface impact control
Tool collision avoidance
Multi-user, multi-tasking system software
Open software interfaces for factory integration
SQL database engine
Programmable light settings fiducial camera

COMPONENT RANGE	
HIGH SPEED MOUNTHEAD—MIDAS	
Component range	Chip (from 03015), SOIC, PLCC, TSOP, QFP, BGA, flip chip, odd-shape, surface-mount connectors, through-hole components, CSP, CCGA, DPAK, Alcap, Tantalum
Component specification	Min: 0.3 x 0.15mm (0.012 x 0.006") (03015) Max: 140 x 73 x 15mm (5.51 x 2.87 x 0.59") (1) (3) Max: component weight: 140 g (2)

- (1) With 4K vision. Max component size with 2K vision: 140×56×15mm (5.51×2.20×0.59"). Customized tall component capability 22mm (0.86") available.
 (2) Depending on mounthead, mount tool, package, and production allitude.
 (3) Components with diagonal larger than 58mm must be presented in the same angle as placed.

HIGH SPEED MOUNTHEAD—HYDRA Z8L		
Component range	Chip (from 0201), SOT23, SOT223, MELF, SOD, SO14	
Component specification	Min: 0.6 x 0.3 mm (0.02 x 0.01") (0201) Max: 8.70 x 8.70 x 5.60 mm (0.34 x 0.34 x 0.22")	

ELECTRICAL VERIFIER (OPTIONAL)	
Component range	Resistor, capacitor, unipolar capacitor, diode (forward voltage, reverse current), Zener diode (reverse voltage), bipolar transistor (current gain), FET/IGBT (gate threshold voltage). Smallest chip size 1.0 x 0.5 mm (0.04 x 0.02").

FEEDER CAPACITY		
8 MM TAPE	T460	T640
MY300LX-11	128	112
MY300LX-15	192	176

BOARD HANDLING		
INLINE CONVEYOR	T460	T640
Maximum board size	460 x 510 mm (18 x 20")	640×510 mm (25×20")
Minimum board size	70×50mm (2.7×2")	70×50mm (2.7×2")
Board thickness range	0.4-6.0mm (0.016-0.24")	0.4-6.0mm (0.016-0.24")
Board edge clearance top	3.2mm (0.13")	3.2mm (0.13")
Board edge clearance bottom (1)	3.2mm (0.13")	3.2mm (0.13")
Top side clearance (max) (2)	5.6mm (0.22")	5.6mm (0.22")
Bottom side clearance (max) (3)	32mm (1.25")	32mm (1.25")
Maximum board weight	4kg (8.8lbs)	4kg (8.8lbs)
Board transfer height	Conforms to SMEMA standard for board transfer height. Height adjustable from 880 to 975mm (34.6 to 38.4").	
Operation mode	Inline, manual, inline odd-board, left-to-right/right-to-left.	

- (1) Edge clearance $5.5 \, \text{mm}$ (0.22") if component taller than $6 \, \text{mm}$ (0.24"). $14.3 \, \text{mm}$ (0.56") if taller than $19 \, \text{mm}$ (0.75"). (2) Customized tall component capability $22 \, \text{mm}$ (0.86") available. (3) $15 \, \text{mm}$ (0.59") with support pins.

VISION CAPABILITY			
INESCAN VISION SYSTEM—4K RESOLUTION			
Component type Field of View Minimum pitch Minimum lea			
Leaded components	80mm(3.1")	0.10mm(4mil)	0.05mm(2mil)
Bumped components	80mm(3.1")	0.15mm(6mil)	0.08mm(3mil)

LINESCAN VISION SYSTEM—2K RESOLUTION			
Component type	Field of View	Minimum pitch	Minimum lead width
Leaded components	63mm (2.5")	0.20mm (8mil)	0.10 mm (4 mil)
Bumped components	63mm (2.5")	0.25mm (10mil)	0.13mm (5mil)

SOFTWARE
SOFTWARE MODULES (OPTIONAL)
Shared databases
Line mode
PCB ID (2D barcode)
Pre-pick inspection
Barcode software
PRM software

OFFLINE SOFTWARE TOOLS (OPTIONAL)
Data preparation—MYCenter
Optimization and scheduling—MYPlan
Inventory management and kitting—MYCenter
Traceability-MYTrace
Performance monitoring—MYCenter Analysis

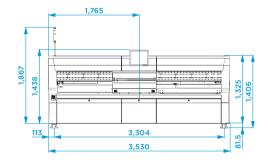
MISCELLANEOUS		
INSTALLATION REQUIREM	ENTS	
Power requirements	Three phase AC 6.6kVA (3x2.2kVA)	
Power consumption	1.5kW (average)	
Voltages	3×200, 210, 220, 230, 240, 250±10%, Y or Delta	
Air supply	No air required	
Noise	70dBA	
Air temperature	+18 to +35°C (65 to 95°F)	
Air humidity	<95% RH non condensing	

MACHINE WEIGHT (1)	
MY300LX-11	1,600kg (3,500lbs)
MY300LX-15	2,200kg (4,850lbs)

⁽¹⁾ Total machine weight excluding magazines.

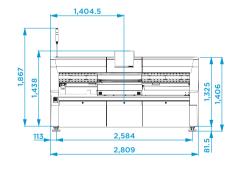
DIMENSIONS [mm]

MY300LX-15





MY300LX-11





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Specifications are subject to change without notice. Mycronic, MYDATA, MYDATA automation and MY; Mycronic 4.0; MYPro, MYPro, Line, MY100, MY100e, MY200, MY200DX, MY200DX, MY200DX, MY300DX, MY300DX, MY300DX, MY300DX, MY500D, MY600JD, MY600JP, MY600JP, MY600JP, MY700JD, MY700JD, MY700JD, MY700JD, MY700JD, MY700JD, MY700JD, MY700JP, MY20DX, MY20DX, MY50D, MYD10, MYD50, MY10D, MYD50, MY10D, MY10D, MY10DX, MY20DX, M